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RoHS



# Vishay General Semiconductor

# Surface Mount TRANSZORB® Transient Voltage Suppressors



| DO-214AA (SMBJ |
|----------------|
|----------------|

| PRIMARY CHARACTERISTICS                 |                 |  |  |  |  |
|---|-----------------|--|--|--|--|
| V <sub>BR</sub> (uni-directional)       | 4.1 V           |  |  |  |  |
| $V_{WM}$                                | 3.3 V           |  |  |  |  |
| P <sub>PPM</sub>                        | 600 W           |  |  |  |  |
| $P_{D}$                                 | 5 W             |  |  |  |  |
| I <sub>FSM</sub> (uni-directional only) | 60 A            |  |  |  |  |
| T <sub>J</sub> max.                     | 175 °C          |  |  |  |  |
| Polarity                                | Uni-directional |  |  |  |  |
| Package                                 | DO-214AA (SMBJ) |  |  |  |  |

### **FEATURES**

- Uni-directional polarity only
- Peak pulse power: 600 W (10/1000 μs)
- · Excellent clamping capability
- Very fast response time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

### TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting on ICs, MOSFET, signal lines of sensor units specifically for protecting 3.3 V supplied sensitive equipment against transient overvoltages.

### **MECHANICAL DATA**

Case: DO-214AA (SMBJ)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant and commercial grade Base P/NHE3 - RoHS-compliant and AEC-Q101 qualified

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 2 whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

| <b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted) |                                   |             |      |  |  |  |
|--|-----------------------------------|-------------|------|--|--|--|
| PARAMETER  | SYMBOL                            | VALUE       | UNIT |  |  |  |
| Peak pulse power dissipation (1)(2)                                    | P <sub>PPM</sub>                  | 600         | W    |  |  |  |
| Peak pulse current with a 10/1000 µs waveform (fig. 1)                 | I <sub>PP</sub>                   | 50          | А    |  |  |  |
| Peak pulse current with a 8/20 μs waveform (fig. 1)                    | I <sub>PPM</sub>                  | 200         | А    |  |  |  |
| Peak forward surge current 8.3 ms single half sine-wave (2)            | I <sub>FSM</sub>                  | 60          | Α    |  |  |  |
| Power dissipation on infinite heatsink, T <sub>A</sub> = 75 °C         | P <sub>D</sub>                    | 5           | W    |  |  |  |
| Operating junction and storage temperature range                       | T <sub>J</sub> , T <sub>STG</sub> | -65 to +175 | °C   |  |  |  |

### Notes

- (1) Non-repetitive current pulse, per fig. 1
- (2) Mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pads to each terminal

| <b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted) |                     |      |                               |  |                 |   |    |      |                                 |                      |      |   |  |                    |                                |
|---|---------------------|------|-------------------------------|--|-----------------|---|----|------|---------------------------------|----------------------|------|---|--|--------------------|--------------------------------|
| DEVICE  | DEVICE VOLTAGE REVE |      | MAXIMUM<br>REVERSE<br>LEAKAGE | EVERSE STAND-OFF<br>EAKAGE VOLTAGE           |                 | MAXIMUM<br>CLAMPING<br>VOLTAGE                  |    | AGE  | TYPICAL TEMPERATURE COEFFICIENT | CAPACITANCE          |      |   |  |                    |                                |
| TYPE  | CODE                | MIN. |                               | CURRENT<br>I <sub>R</sub> AT V <sub>WM</sub> | V <sub>WM</sub> | V <sub>C</sub> AT I <sub>PP</sub><br>10/1000 μs |    |      |                                 |                      |      | V <sub>C</sub> AT I <sub>PPM</sub><br>8/20 μs |  | OF V <sub>BR</sub> | C <sub>J</sub> AT 0 V<br>1 MHz |
|   |                     | ٧    | mA                            | μA   | V               | ٧   | Α  | ٧    | Α                               | 10 <sup>-4</sup> /°C | pF   |   |  |                    |                                |
| SMBJ3V3   | KC                  | 4.1  | 1.0                           | 200  | 3.3             | 7.3   | 50 | 10.3 | 200                             | -5.3                 | 5200 |   |  |                    |                                |



# Vishay General Semiconductor

| THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted) |                |       |      |  |  |  |
|---|----------------|-------|------|--|--|--|
| PARAMETER   | SYMBOL         | VALUE | UNIT |  |  |  |
| Typical thermal resistance, junction to lead (1)                        | $R_{	heta JL}$ | 20    | °C/W |  |  |  |
| Typical thermal resistance, junction to ambient (2)                     | $R_{	hetaJA}$  | 100   | C/ W |  |  |  |

### **Notes**

- (1) Thermal resistance from junction to lead mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pads to each terminal
- (2) Thermal resistance from junction to ambient mounted on the recommended PCB pad layout

| ORDERING INFORMATION (Example) |                 |                        |               |                                    |  |  |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|--|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |  |  |
| SMBJ3V3-E3/52                  | 0.096           | 52                     | 750           | 7" diameter plastic tape and reel  |  |  |
| SMBJ3V3-E3/5B                  | 0.096           | 5B                     | 3200          | 13" diameter plastic tape and reel |  |  |
| SMBJ3V3HE3/52 (1)              | 0.096           | 52                     | 750           | 7" diameter plastic tape and reel  |  |  |
| SMBJ3V3HE3/5B (1)              | 0.096           | 5B                     | 3200          | 13" diameter plastic tape and reel |  |  |

### Note

(1) AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

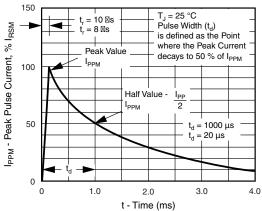


Fig. 1 - Pulse Wave Form

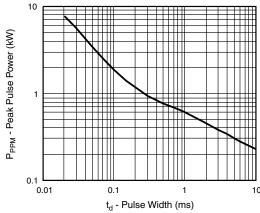


Fig. 2 - Peak Pulse Power Rating Curve

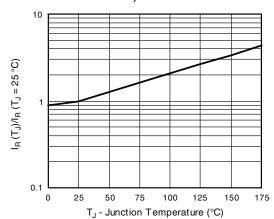


Fig. 3 - Relative Variation of Leakage Current vs.
Junction Temperature

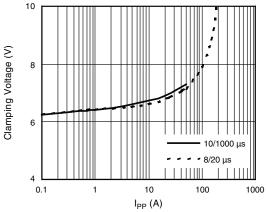


Fig. 4 - Clamping Voltage vs. Peak Pulse Current (T<sub>J</sub> initial = 25 °C)



# Vishay General Semiconductor

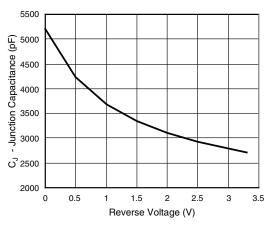
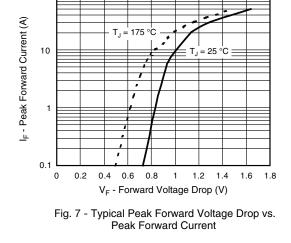


Fig. 5 - Typical Junction Capacitance



100

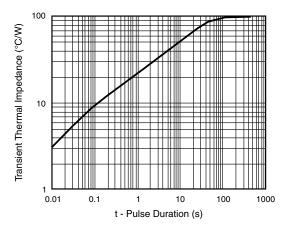


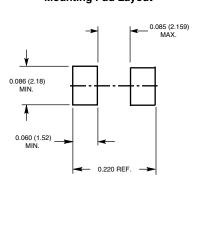
Fig. 6 - Typical Transient Thermal Impedance

# PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

# 0.086 (2.20) 0.077 (1.95) 0.180 (4.57) 0.160 (4.06) 0.096 (2.44) 0.084 (2.13) 0.096 (2.44) 0.084 (2.13) 0.008 (0.2) 0.008 (0.2) 0.008 (0.2) 0.008 (0.2) 0.008 (0.2)

DO-214AA (SMB-J-Bend)

### Mounting Pad Layout





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